

# IRFU220NPBF-VB Datasheet N-Channel 200 V (D-S) MOSFET

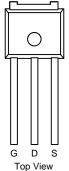
PRODUCT	SUMMARY	
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)
200	0.270 at V <sub>GS</sub> = 10 V	8

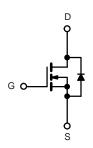
#### **FEATURES**

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC









N-Channel MOSFET

### **APPLICATIONS**

· Primary Side Switch

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, unless otherwise noted)							
Parameter	Symbol	Limit	Unit				
Drain-Source Voltage	V <sub>DS</sub>	200	V				
Gate-Source Voltage	V <sub>GS</sub>	± 20	v				
Continuous Proin Compant /T 475 90\b	T <sub>C</sub> = 25 °C	I-	8				
Continuous Drain Current (T <sub>J</sub> = 175 °C) <sup>b</sup>	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	5				
Pulsed Drain Current	I <sub>DM</sub>	25	А				
Continuous Source Current (Diode Conduction)	I <sub>S</sub>	5					
Avalanche Current	I <sub>AS</sub>	5					
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	18	mJ			
Manison Danier Dissipation	T <sub>C</sub> = 25 °C	В	96 <sup>b</sup>	14/			
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3 <sup>a</sup>	W			
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C				

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
lunation to Ambiant	t ≤ 10 s	R <sub>thJA</sub>	15	18			
Junction-to-Ambient <sup>a</sup>	Steady State	NthJA	40	50	°C/W		
Junction-to-Case (Drain)		R <sub>thJC</sub>	0.85	1.1			

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. See SOA curve for voltage derating.

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Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50	μА	
		V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	40			Α	
		$V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$		0.270			
D : 0	D	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A, T <sub>J</sub> = 125 °C		0.300		Ω	
Orain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A, T <sub>J</sub> = 175 °C		0.320			
		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 3 A		0.310			
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 3 A		35		S	
Dynamic <sup>a</sup>							
Input Capacitance	C <sub>iss</sub>			800		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, F = 1 MHz		100			
Reverse Transfer Capacitance	C <sub>rss</sub>			50			
Total Gate Charge <sup>c</sup>	$Q_g$			34	51		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$		8		nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			12			
Gate Resistance	$R_g$		0.5		2.9	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			15	25		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 100 \text{ V}, R_{L} = 5.2 \Omega$		50	75	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 3 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		30	45		
Fall Time <sup>c</sup>	t <sub>f</sub>			60	90		
Source-Drain Diode Ratings and Char	acteristics (T	<sub>C</sub> = 25 °C)					
Pulsed Current	I <sub>SM</sub>				5	А	
Diode Forward Voltage <sup>b</sup>	V <sub>SD</sub>	I <sub>F</sub> = 3 A, V <sub>GS</sub> = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 3 A, dI/dt = 100 A/µs		180	250	ns	

#### Notes:

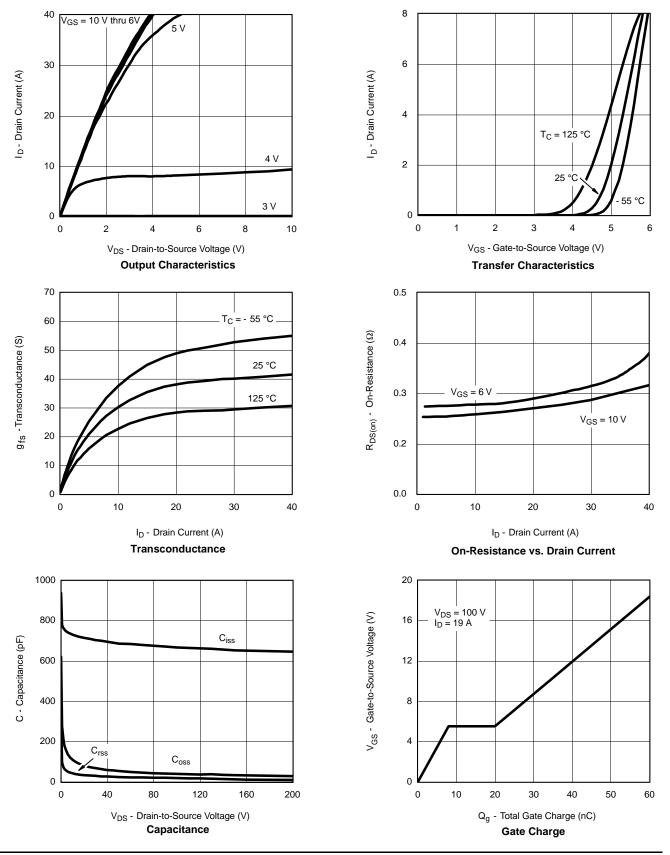
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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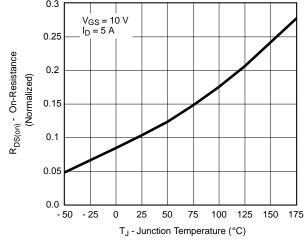
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



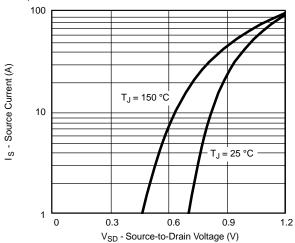
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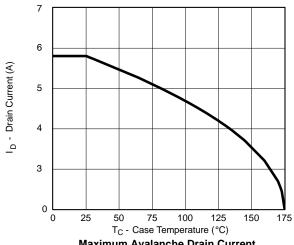


On-Resistance vs. Junction Temperature

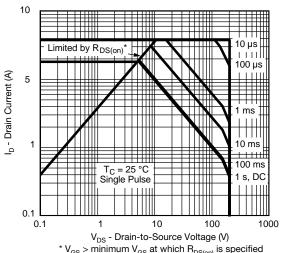


Source-Drain Diode Forward Voltage

#### THERMAL RATINGS

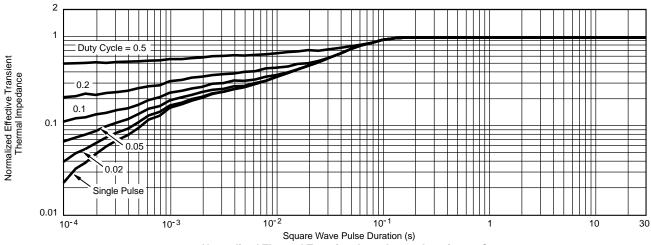


Maximum Avalanche Drain Current vs. Case Temperature



\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

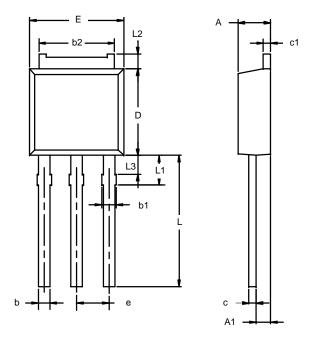
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case



### **TO-251AA**



Note: Dimension L3 is for reference only.

	MILLIM	IETERS	INCHES				
Dim	Min	Max	Min	Max			
Α	2.21	2.38	0.087	0.094			
A1	0.89	1.14	0.035	0.045			
b	0.71	0.89	0.028	0.035			
b1	0.76	1.14	0.030	0.045			
b2	5.23	5.43	0.206	0.214			
С	0.46	0.58	0.018	0.023			
с1	0.46	0.58	0.018	0.023			
D	5.97	6.22	0.235	0.245			
Е	6.48	6.73	0.255	0.265			
е	2.28 BSC		0.090 BSC				
L	3.89	9.53	0.153	0.375			
L1	1.91	2.28	0.075	0.090			
L2	0.89	1.27	0.035	0.050			
L3	1.15	1.52	0.045	0.060			
ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346							

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